200W, 28V High Power RF LDMOS FETs

Description

The MX1520C is a 200-watt high performance, unmatched LDMOS FET, designed for wide-band commercial and industrial applications with frequencies HF to 1.5 GHz.

• Typical performance(on 108-512MHz wideband board with device soldered)

Signal: Two-tone space 1.6MHz , Vgs=2.75V,Vds=28V, Idq=900mA

Freq(MHz)	Pin(dBm)	Pav(W)	lds(A)	Gain(dB)	Eff(%)	IMD3
48	23	40	4.56	23	31	-30
58	22.2	40	4.3	23.8	33	-32
68	22	40	4.06	24	35	-32
88	21.6	40	3.75	24.4	38	-32
108	21.4	40	3.57	24.6	40	-33
150	21.8	40	3.51	24.2	41	-32
200	21.5	40	3.52	24.5	40	-37
225	22.4	40	3.56	23.6	40	-38
250	23.1	40	3.6	22.9	39	-39
300	23	40	3.65	23	39	-40
350	22.2	40	3.63	23.8	39	-37
400	22.6	40	3.56	23.4	40	-33
450	23.1	40	3.64	22.9	39	-34
512	22.7	40	3.81	23.3	37	-32

Features

- High Efficiency and Linear Gain Operations
- Integrated ESD Protection
- Excellent thermal stability, low HCI drift

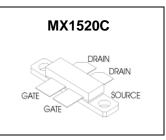
Suitable Applications

- 2-30MHz (HF or Short wave communication)
- 30-88MHz (Ground communication)
- 54-88MHz (TV VHF I)
- 88-108MHz (FM)
- 118 -140MHz (Avionics)

- Large Positive and Negative Gate/Source Voltage Range for Improved Class C Operation
- Pb-free, RoHS-compliant
- 136-174MHz (Commercial ground communication)
- 160-230MHz (TV VHF III)
- 30-512MHz (Jammer, Ground/Air communication)
- 470-860MHz (TV UHF)
- 100kHz 1000MHz (ISM, instrumentation)

Table 1. Maximum Ratings

Rating	Symbol	Value	Unit
DrainSource Voltage	V _{DSS}	+65	Vdc
GateSource Voltage	V_{gs}	-10 to +10	Vdc
Operating Voltage	V _{DD}	+32	Vdc
Storage Temperature Range	Tstg	-65 to +150	°C



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ase Operating Temperature		T _c +150				°C	
Operating Junction Temperature		TJ		+225		°C	
Table 2. Thermal Characteristics							
Characteristic		Symbol	Va	Value		Unit	
Thermal Resistance, Junction to Case							
T_{C} = 85°C, T_{J} =200°C, DC test		Rejc	0	0.35		°C/W	
Table 3. ESD Protection Characteristics					•		
Test Methodology		Class					
Human Body Model (per JESD22A114)		Class 2					
Table 4. Electrical Characteristics ($T_A = 25$ °C unless oth	nerwise r	noted)					
Characteristic		Symbol	Min	Тур	Max	Unit	
DC Characteristics (per half section)							
Drain-Source Voltage		M	GE			V	
V_{GS} =0, I_{DS} =1.0mA		$V_{(BR)DSS}$	65			V	
Zero Gate Voltage Drain Leakage Current		1			1	۵	
$(V_{DS} = 28 \text{ V}, V_{GS} = 0 \text{ V})$		DSS			I	μΑ	
GateSource Leakage Current		1			1	μΑ	
$(V_{GS} = 10 \text{ V}, V_{DS} = 0 \text{ V})$		I _{GSS}					
Gate Threshold Voltage		V _{GS} (th)	b)	1.98		V	
$(V_{DS} = 28V, I_{D} = 600 \ \mu A)$		V GS(UI)		1.90		v	
Gate Quiescent Voltage		$V_{GS(Q)}$		2.53		V	
(V_{DD} = 28 V, I_D = 220 mA, Measured in Functional Test)		• GS(Q)		2.00		,	
Drain source on state resistance		Rds(on)		100		mΩ	
$(V_{DS} = 0.1V, V_{GS} = 10 V)$				100		11132	
Common Source Input Capacitance		C _{ISS}		92		pF	
$(V_{GS} = 0V, V_{DS} = 28 V, f = 1 MHz)$		- 100				'	
Common Source Output Capacitance		Coss		39		pF	
(V _{GS} = 0V, V _{DS} =28 V, f = 1 MHz)		- 000				'	
Common Source Feedback Capacitance		C _{RSS}		1.58		pF	
(V _{GS} = 0V, V _{DS} =28 V, f = 1 MHz)							
Functional Tests (In Demo Test Fixture, 50 ohm system) V _{DD} = 28 Vdc, I _{DQ} = 220 mA, f = 1300 MHz, CW Signal Measurements.							
Power Gain		Gp		18		dB	
Drain Efficiency@P1dB		η_{D}		65		%	
1 dB Compression Point		P _{-1dB}		200		W	
Input Return Loss				-7		dB	
Load Mismatch (In Innogration Test Fixture, 50 ohm system): V _{DD} = 28 Vdc, I _{DQ} = 220 mA, f = 1300 MHz							
VSWR 10:1 at 200W CW Output Power No Device Degradation							

Figure 1: 108-512MHz wideband application circuit picture

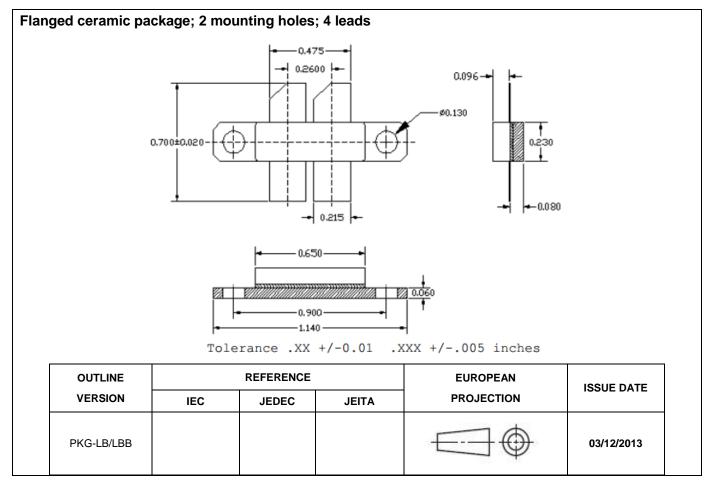


Bill of Materials

Γ

C1,C2,C6, C7,C8,C9, C10,C13, C14	1000PF	ATC100B	
C3,C4,C5, C11,C12	1UF	1UF/50V	
R1,R2	10Ω	1206	
R3,R4,R5, R6	1000Ω		
R7,R8	51Ω		
T1,T6	50Ω,90mm	No.61	
T2,T3	12Ω,70mm	No.61	
T4,T5	25Ω,120mm		
L1,L2	5 Turns	D=3mm	

Package Outline



Revision history

Table 5. Document revision history

Date	Revision	Datasheet Status
2017/10/13	Rev 1.0	Product Datasheet Creation

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